

Harvatek Surface Mount CHIP LEDs Data Sheet B19Y1TX--20P001713U1930

Official Product	HT Part No. B19Y1TX20P001713U1930					
Tentative Product	************					
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DISCLAIMER

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HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specifications

Item	Specification	Material	Quantity
Luminous	800.0-2010.0 mcd		
Intensity(Iv)	@20 mA/ $T_S = 25^{\circ}C$; Tolerance: ±10%		
Chromaticity	As page 6 & 7		
Coordinate	@20 mA/ $T_S = 25^{\circ}C$; Tolerance: ±0.007		
Vf	2.7-3.5 V		
	@20 mA/ $T_S = 25^{\circ}C$; Tolerance: ±0.05V		
Ir	< 10 µA @ V _R = 5 V		
Resin	Yellow	Ероху	
Carrier tape	EIA 481-1A specs	Conductive black tape	
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	250x230mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, CIE and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note: This is shipped test conditions

*Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlGaInP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must

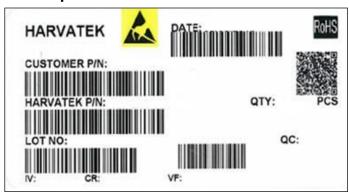
be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

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Label Specifications



Harvatek P/N:

B 19Y 1 TX-- 20P- 0017 13

Product	Package	Dice Q'ty	Color	Current	Series Number	Taping
PCB	1.6(L)x0.8(W)x0.2(H) mm	1:Single	TX:White	20mA	X001~XZZZ	1.Taping style
						2. Q'ty

Lot No.:

1	2	3	4	5	6	7	8	9	10
Ε	1	A	1	Α	2	2	L	1	2
Cod	e 1 2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number	\	Special code	e
Internal Tra	acing Code	2020-L 2021-M 2022-P 2023-Q 2026-T 2027-V 2030-Y 2031-Z	1:Jan. 2:Feb. A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C 26:Z 27:7 28:8 29:9 30:3 31:4	01-	-ZZ		000~ZZZ	

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Specifications Range

■Luminous Intensity (Iv) Bin:

Color	Bin Code	Spec. Range
	X2	800.0-900.0 mcd
	Y	900.0-1125.0 mcd
тх	Z	1125.0-1440.0 mcd
	AA	1440.0-1800.0 mcd
	AB1	1800.0-2010.0 mcd

Note: It maintains a tolerance of ±10% on Luminous Intensity

■Color Bin:

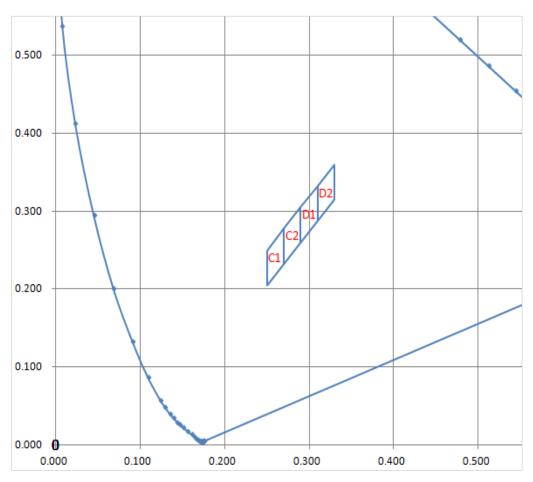
	Bin Code	Spec.	Range	Bin Code	Spec.	Range
тх	C1	X 0.2500 0.2500 0.2700 0.2700	Y 0.2050 0.2500 0.2775 0.2325	C2	X 0.2700 0.2700 0.2900 0.2900	Y 0.2325 0.2775 0.3050 0.2600
	D1	X 0.2900 0.2900 0.3100 0.3100	Y 0.2600 0.3050 0.3325 0.2875	D2	X 0.3100 0.3100 0.3300 0.3300	Y 0.2875 0.3325 0.3600 0.3150

Note: It maintains a tolerance of x,y ±0.007

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■Chromaticity Coordinate



■Forward Voltage (Vf) Bin:

Color	Bin Code	Spec. Range
	G8	2.7-2.9 V
TV	Н7	2.9-3.1 V
TX	Н8	3.1-3.3V
	J7	3.3-3.5 V

Note: It maintains a tolerance of ± 0.05 V on forward voltage measurements

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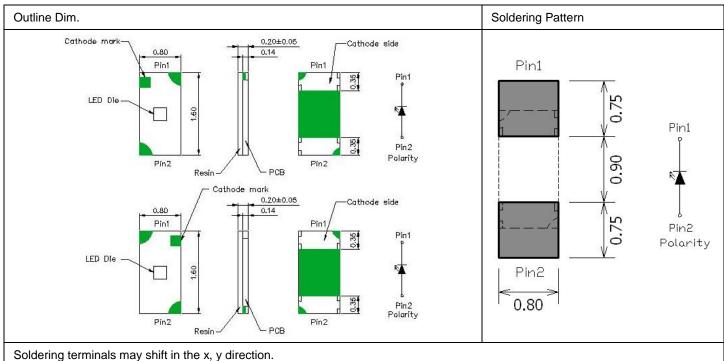
Product Features

Electro-Optical Characteristics

						(T:	Soldering, 25°C)		
Corios	Emitting Color	Motorial	V _F	(V)	Chromaticity Coordinate	I _V (mcd)	Viewing		
Series Emitting Color	Material	typ	max	x,y	Typical	Angle $2\theta \frac{1}{2}$			
P10V1TV 20	TV	In CoN	2.1	2.5	v_0 2000 v_0 2950	1250	X : 120		
D19111A20	Y1TX20 TX		TX20 TX InGaN		3.1 3.5		x=0.2900,y=0.2850	1250	Y: 135

Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

(Unit: mm Tolerance: +/-0.1)



Absolute Maximum Ratings

(T_{Soldering} ,25°C)

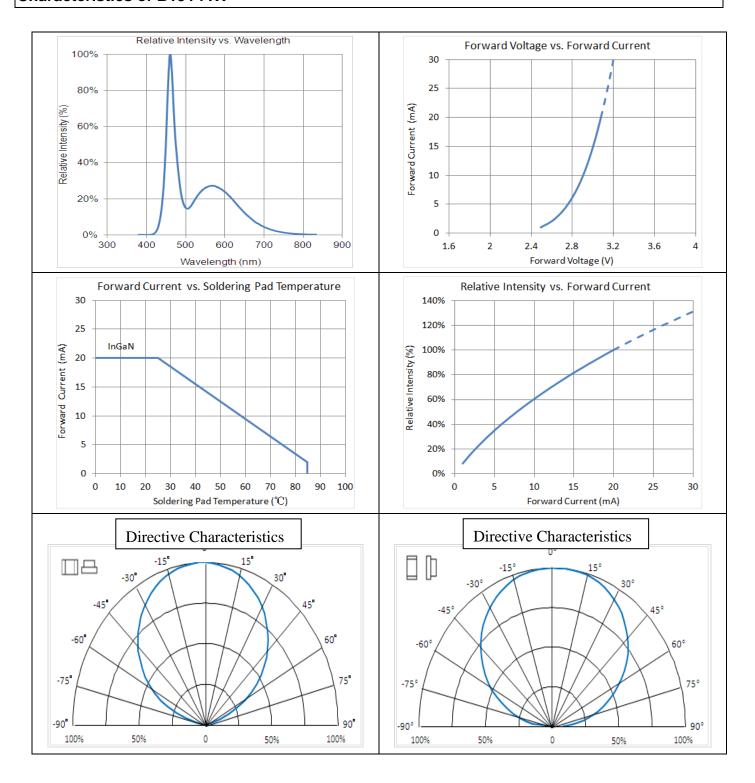
Series	P _D (mW)	I _F (mA)	I _{FP} (mA)*	T _{OP} (°C)	T _{ST} (℃)
Color	Dower Dissipation	Forward Current	Pulse Forward	Operating	Storage
Coloi	Power Dissipation	Forward Current	Current	Temperature	Temperature
TX	70	20	80	-40~+85	-40~+100

^{*} Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

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Characteristics of B19Y1TX



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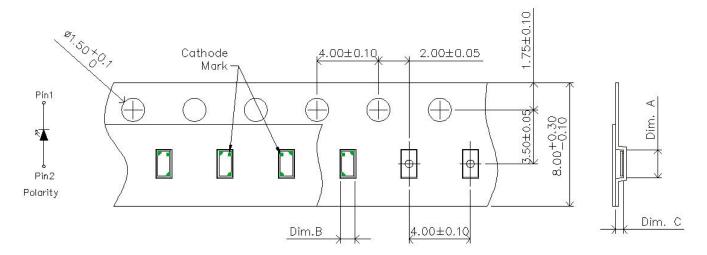
Precaution for Use

- 1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
- 2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
- 3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
- 4. The LEDs must be used within 72 hours after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
- 5. The appearance and specifications of the products may be modified for improvement without further notice.
- 6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs.If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs.Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

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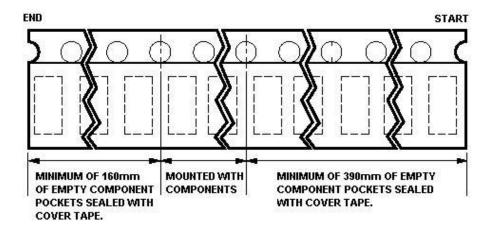


Packaging Tape Dimension



Dim. A	Dim. B	Dim. C	Q'ty/Reel
1.77±0.05	0.97±0.05	0.51±0.05	3K

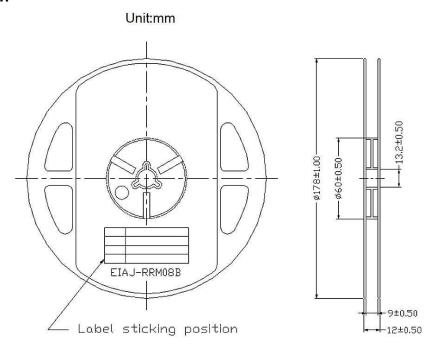
Unit: mm



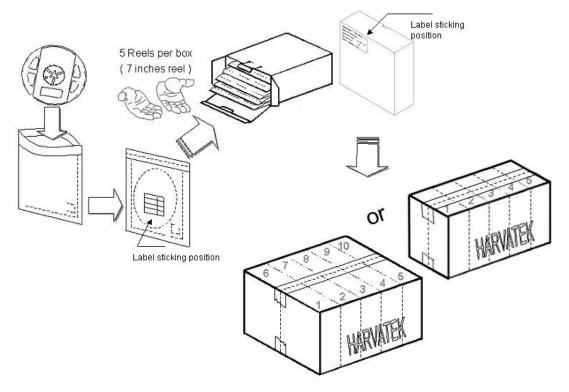
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Reel Dimension



Packing



5 or 10 boxes per carton is available depending on shipment quantity.

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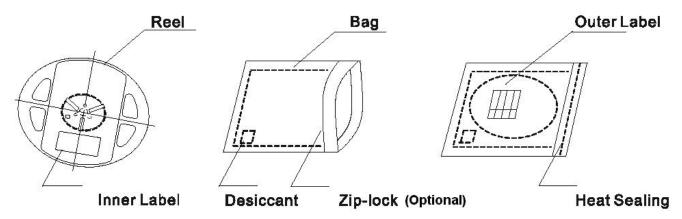


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 72 hours. The conditions are as followings:

- 1. $60\pm3^{\circ}$ x(12~24hrs)and<5%RH, taped reel type.
- 2. $100\pm3^{\circ}$ C ×(45min~1hr), bulk type.
- 3. $130\pm3^{\circ}$ C ×(15min~30min), bulk type.

Precautions

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlGaInP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

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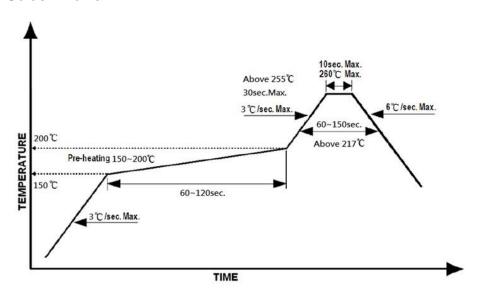


Reflow Soldering

Recommend soldering paste specifications:

- 1. Operating temp.: Above 217°C ,60~150 sec
- 2. Peak temp.:260°C Max.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260°C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100°C max, <3min

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Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Revise History

Rev.	Descriptions	Date	Page
1.0	Official Version	08/27/2019	-
1.1	Renew form and add customer code	11/10/2021	5
1.2	Renew form and add customer code	06/03/2022	5,12

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